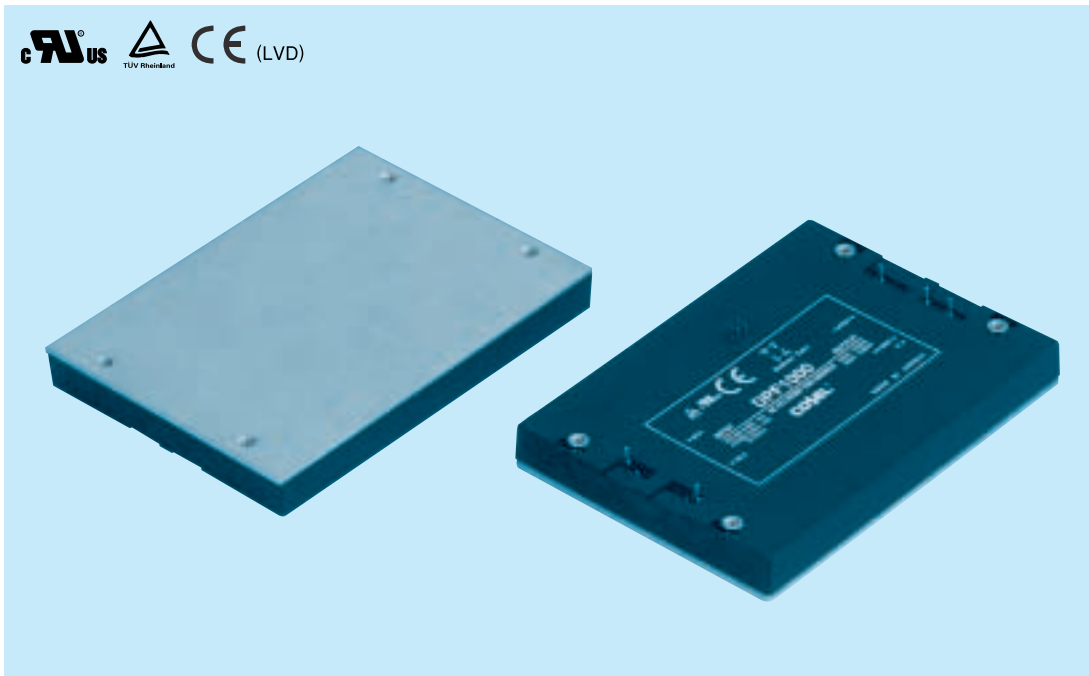


DPF1

DPF 1000

① ②

① Series name
② Output wattage



MODEL	DPF1000	
AC INPUT[V]	AC85 - 264	AC170 - 264
MAX OUTPUT WATTAGE[W]	1,000	1,500
DC OUTPUT VOLTAGE[V]	DC360	

SPECIFICATIONS

	MODEL	DPF1000
INPUT	VOLTAGE[V]	AC85 - 264 1 φ
	POWER FACTOR CORRECTION RANGE[V]	AC85 - 255 1 φ
	CURRENT[A]	11.5typ (ACIN 100V)
	FREQUENCY[Hz]	50/60 (47 - 63)
	INRUSH CURRENT[A]	Limited by external resistance
	EFFICIENCY[%]	90typ (ACIN 100V)
	POWER FACTOR	0.98typ (ACIN 100V)
	LEAKAGE CURRENT[mA]	0.75max (60Hz, According to IEC60950 and DEN-AN)
OUTPUT	WATTAGE[W] *1	1,000
	VOLTAGE[V] *2	DC360
	VOLTAGE ACCURACY[V] *3	±20
PROTECTION CIRCUIT AND OTHERS	OVERVOLTAGE PROTECTION[V]	DC400 - 450 The power factor corrector function stops
	IOG	Inverter operation monitoring, Open-collector output, Maximum sink current 10mA, Maximum allowance voltage 35V
	ENA	Enable signal, Open-collector output, Maximum sink current 10mA, Maximum allowance voltage 35V
	AUX	Auxiliary power supply for external signal, Output voltage:6.5 - 8.5V maximum, Output current:10mA
	OTHERS	Parallel operation possible (Current balancing function), N+1 redundant operation possible, Thermal protection
ISOLATION	INPUT-OUTPUT	Non isolated
	INPUT, OUTPUT-FG	AC3.000V 1minute Cutoff current = 10mA, DC500V, 50MΩmin (20±15°C)
ENVIRONMENT	OPERATING TEMP.,HUMID.AND ALTITUDE	-20 to +85°C (Aluminum base plate), 20 - 95%RH (Non condensing) (Refer to DERATING CURVE), 3,000m (10,000feet) max
	STORAGE TEMP.,HUMID.AND ALTITUDE	-40 to +85°C, 20 - 95%RH (Non condensing), 9,000m (30,000feet) max
	VIBRATION	10 - 55Hz, 49.0m/s ² (5G), 3minutes period, 60minutes each along X, Y and Z axis
	IMPACT	196.1m/s ² (20G), 11ms, once each X, Y and Z axis
SAFETY	AGENCY APPROVALS	UL1950, C-UL, EN60950, EN50178 Complies with DEN-AN and IEC60950
	HARMONIC ATTENUATOR	Complies with IEC61000-3-2
OTHERS	CASE SIZE/WEIGHT	118.6 × 12.7 × 85mm (W × H × D) /200g max
	COOLING METHOD	Conduction cooling (e.g. heat radiation from the aluminum base plate to the attached heat sink)

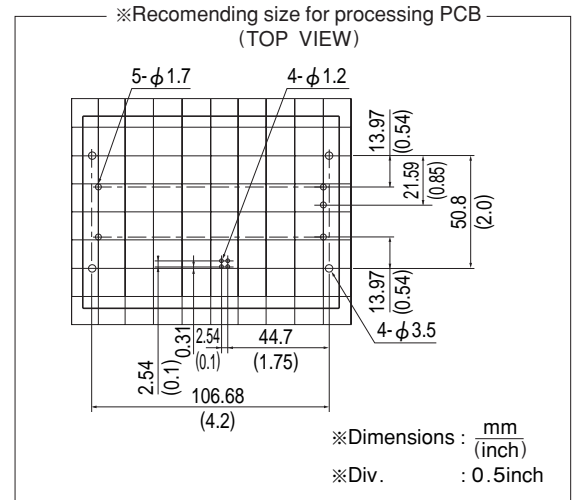
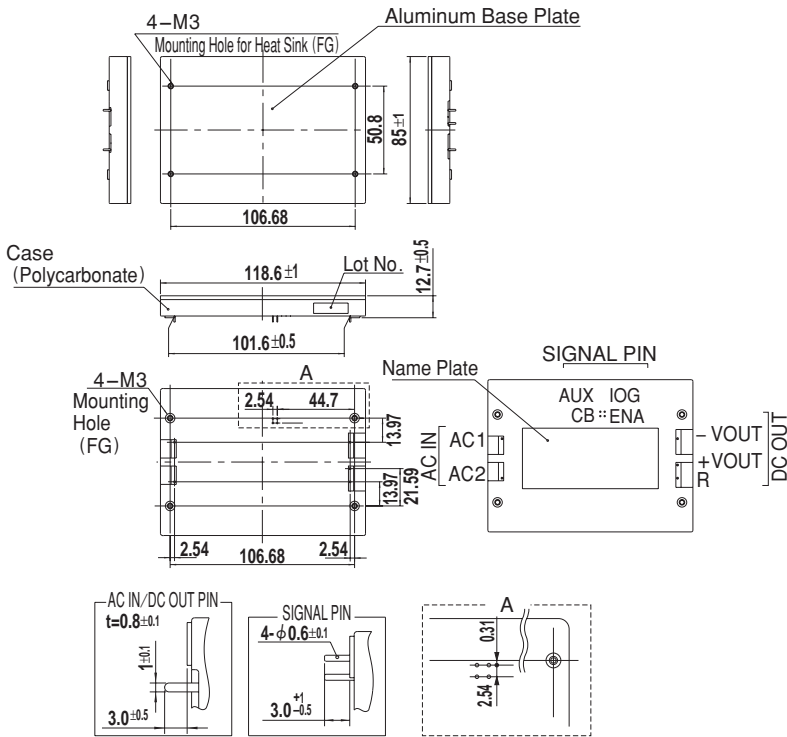
*1 Refer to Input voltage derating.

*2 When the input voltage is more than 255V, the power factor corrector function stops, and the output voltage becomes rectified AC input voltage.

*3 The value included the output setting and the line regulation, the load regulation and the temperature regulation.

However, the input voltage is in the power factor correction range.

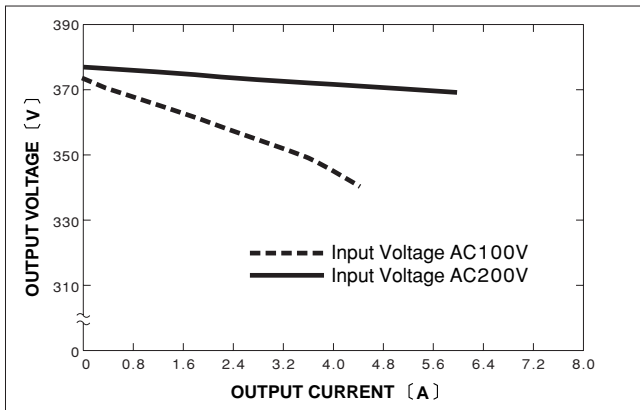
External view



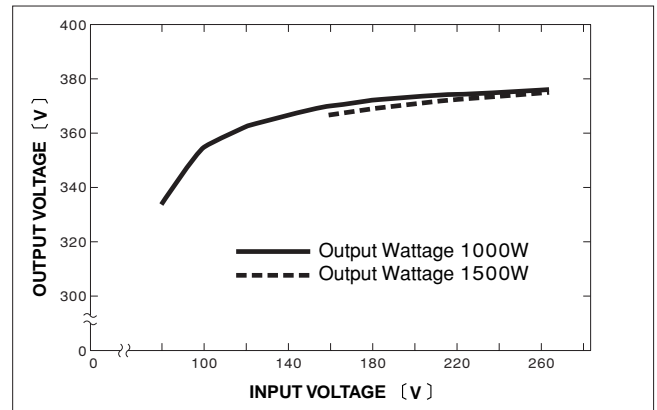
- ※Weight: 200g or less.
- ※Tolerance: ±0.3
- ※Base Plate: Aluminum
- ※Mounting torque
- Mounting hole screwing torque 0.4N·m (5.0kgf·cm) max

Performance data

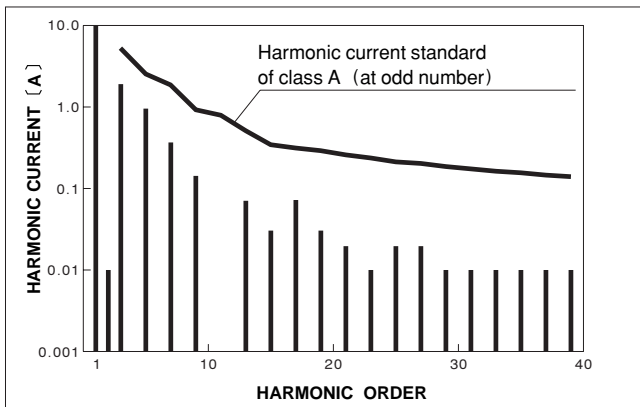
■ STATIC CHARACTERISTICS



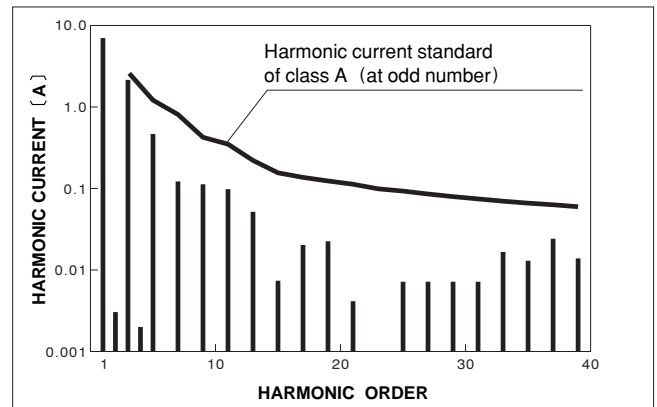
■ OUTPUT VOLTAGE FOR INPUT



■ HARMONIC CURRENT (AC100V)



■ HARMONIC CURRENT (AC230V)



Basic Characteristics Data

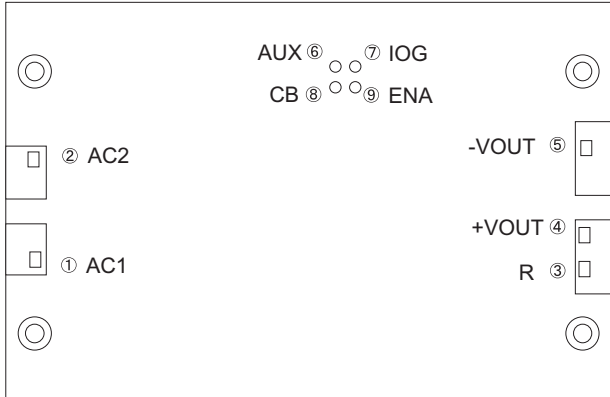
Model	Circuit method	Switching frequency [kHz]	Input current [A]	Rated input fuse	Inrush current protection	PCB/Pattern			Series/Parallel operation availability	
						Material	Single sided	Double sided	Series operation	Parallel operation
DPF1000	Active filter	130	11.5 *1	-	SCR	Aluminum	Yes		No	Yes
			8.5 *2							

*1 The value of input current is at ACIN 100V and 1000W load.

*2 The value of input current is at ACIN 200V and 1500W load.

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1 Pin Connection



* Bottom View

Table 1.1 Pin connection and function

No.	Pin connection	Function
①	AC1	AC Input
②	AC2	
③	R	External resistor for inrush current protection
④	+VOUT	+DC Output
⑤	-VOUT	-DC Output
⑥	AUX	Auxiliary power supply for external signal
⑦	IOG	Inverter operation monitor
⑧	CB	Current balance
⑨	ENA	Enable signal

No.	Reference
①	
②	3.3 "Wiring input pin"
③	3.5 "External resistor for inrush current protection"
④	
⑤	3.4 "Wiring output pin"
⑥	4.4 "Auxiliary power supply for external signal"
⑦	4.5 "Inverter operation monitor"
⑧	5.2 "Parallel operation"
⑨	4.6 "Enable signal"

2 Input Voltage Derating

■ Fig.2.1 shows rated output for each input voltage section. Maximum output should be within this range.

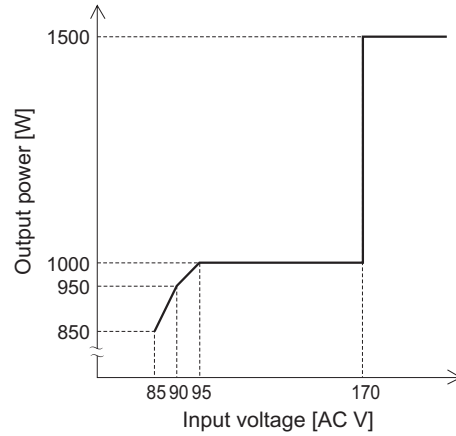


Fig.2.1 Input voltage derating curve

3 Standard Connection Method

3.1 Standard connection method

■ To use DPF1000, connection shown in Fig.3.1 and outside attached components are required. Through this connection, DC output voltage can be obtained from AC input voltage. AC input voltage and DC output voltage are not insulated.

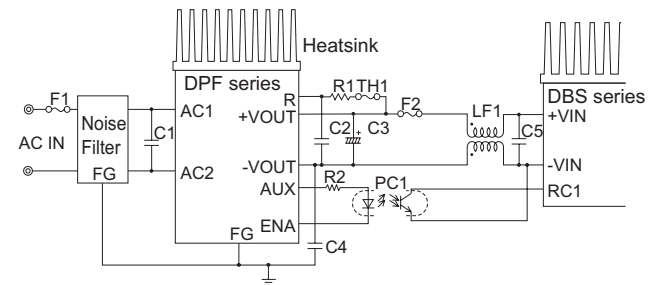


Fig.3.1 Standard connection method

3.2 Heatsink

■ The power supply adopts the conduction cooling system. Attach a heatsink to the aluminum base plate to cool the power supply for use. Refer to 6.5 Derating.

3.3 Wiring input pin

- A noise filter is not built in this power supply. Connect an external noise filter to reduce the conducted noise to the power supply line.
- A fuse to protect input is not built in. To assure safety, install a slow-blow fuse of 20A maximum to the input circuit F1.

3.4 Wiring output pin

- The output filtering capacitor is not built in the power supply. Connect the electrolytic capacitor (220 - 2,200 μ F) near the output terminal. Rated ripple current and hold-up time must be taken into account when selecting C3.
- The overcurrent protection circuit is not built in. To assure safety, attach a normal-blow fuse of 10A maximum to the output circuit F2.

3.5 External resistor for inrush current protection

- Connect the external resistor for inrush current protection R1 between the terminal R and +VOUT. Contact a manufacturer for selecting a resistor which is able to handle the large surge.
To avoid red heat in the case of failure, either use a resistor with built-in temperature fuse type or thermally connect the temperature fuse TH1 in series to the resistor.

3.6 External capacitor

- Connect the input capacitor C1, a film capacitor of 2 μ F minimum. Use rated AC250V with rated ripple current of 9A minimum to meet the safety standards.
- Connect the output capacitor C2, a film capacitor of 1 μ F minimum. Use rated current of 8A minimum in case of over DC400V.
- Connect the grounding capacitor C4, a ceramic capacitor of 2,200pF. Use the capacitor Y with rated AC250V to meet the safety standards.

3.7 Connection of loaded circuit

- For connecting the DBS/DAS series, see Fig.3.1.
For details of F2, LF1 and C5, refer to the instruction manual for the DBS/DAS series.
LF1 may not be required, depending on the noise standard or the design of the printed circuit board. In this case, ENA and RC1 can be directly connected, without having PC1.
- Control load current so that it may flow only when the terminal ENA is at "L". At "H" when inrush current protection circuit is not released, excessive current may be applied to the circuit.
- For connection of loads except the series DBS/DAS, please contact Cosel development department.

4 Function

4.1 Overcurrent protection

- The overcurrent protection circuit is not built-in.

4.2 Overvoltage protection

- The overvoltage protection circuit is built-in. The AC input should be shut down if overvoltage protection is in operation. The minimum interval of AC recycling for recovery is a few minutes which output voltage drops below 20V.

When this function operates, the power factor corrector function does not operate, and output voltage becomes the full-wave rectified AC input voltage.

Remarks:

Please note that the unit's internal components may be damaged if excessive voltage (over rated voltage) is applied to output terminal of power supply. This could happen when the customer tests the overvoltage performance of the unit.

4.3 Thermal protection

- Thermal protection circuit is built-in and it operates at 100 \pm 15 $^{\circ}$ C. If this function comes into effect, shut down the output, eliminate all possible causes of overheating, and drop the temperature to normal level. To prevent the unit from overheating, avoid using the unit in a dusty, poorly ventilated environment.
When this function operates, the power factor corrector function does not operate, and output voltage becomes the full-wave rectified AC input voltage.

4.4 Auxiliary power supply circuit for external signal(AUX)

- The AUX pin can be used as the power source with the open collector output (output voltage DC 6.5 - 8.5V, maximum output current 10mA) for IOG and ENA.
- When used with AUX pin of additional units of this model for parallel connection, make sure to install a diode and that the maximum output current must be below 10mA.
- Never let a short circuit occur between the AUX pin and other pins. It may damage the unit.

4.5 Inverter operation monitor(IOG)

- Use IOG to monitor operation of the inverter. In the case of abnormal operation, display is changed from "L" to "H" within one second. IOG can be used for monitoring failures such as redundant operation.
- IOG may become unstable in case of start-up or sudden change of load current. Set the timer with delay of more than one second.
- During parallel operation, unstable condition may occur when load current becomes lower than 10% of rated value.

4.6 Enable signal (ENA)

- Use ENA to control starting of the loaded power supply.
- When inrush current protection circuit is released, ENA outputs "LOW".
- If load current flows without releasing of the circuit, the resistor may be burnt.

Table 4.1 Specification of TMP, IOG

No.	Item	IOG	ENA
1	Function	Normal operation "L"	Output possible "L"
		Malfunction of inverter "H"	Output prohibited "H"
2	Base pin	-VOUT	
3	Level voltage "L"	0.6V max at 10mA	
4	Level voltage "H"	Open collector	
5	Maximum sink current	10mA max	
6	Maximum applied voltage	35V max	

4.7 Isolation

- For a receiving inspection, such as Hi-Pot test, gradually increase (decrease) the voltage for a start(shut down). Avoid using Hi-Pot tester with the timer because it may generate voltage a few times higher than the applied voltage, at ON/OFF of a timer.

5 Series and Parallel Operation

5.1 Series operation

- As input and output are not insulated, series operation is impossible.

5.2 Parallel operation

- Parallel operation is available by connecting the units as shown in Fig.5.1.
- As variance of output current drew from each power supply is maximum 10%, the total output current must not exceed the value determined by the following equation.

(Output current in parallel operation)
 = (the rated current per unit) × (number of unit) × 0.9

In parallel operation, the maximum operative number of units is 5.

- When the output-line impedance is high, the power supply is become unstable. Use same length and thickness(width) wire(pattern) for the current balance improvement.
- Connect each input pin for the lowest possible impedance. When the number of the units in parallel operation increases, input current increases. Adequate wiring design for input circuitry such as circuit pattern, wiring and current for equipment is required.
- If temperatures of aluminum base plates are different in the power supply for parallel operation, values of output current will change greatly. Design radiation to equalize plate temperatures by attaching the same heatsinks.
- Output diode Di is not required if capacity of output smoothing capacitor for parallel connection is below 2,500μF.

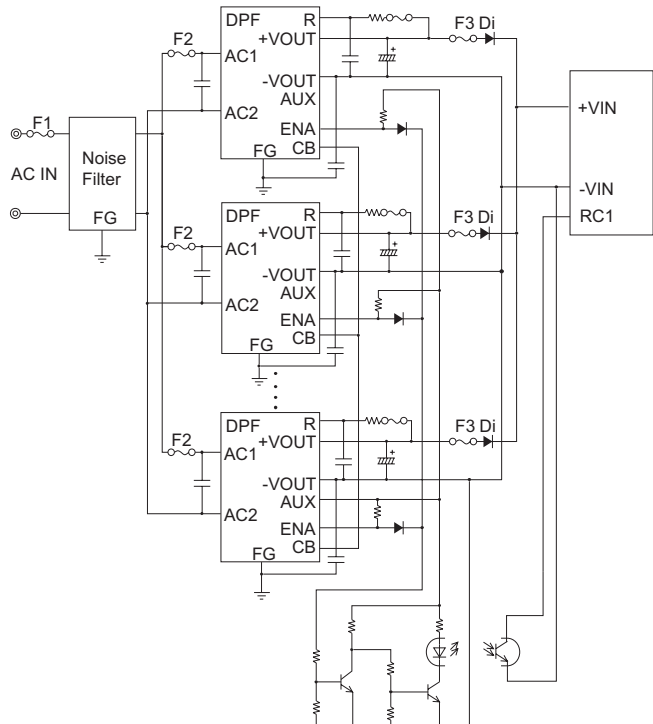


Fig.5.1 Parallel operation

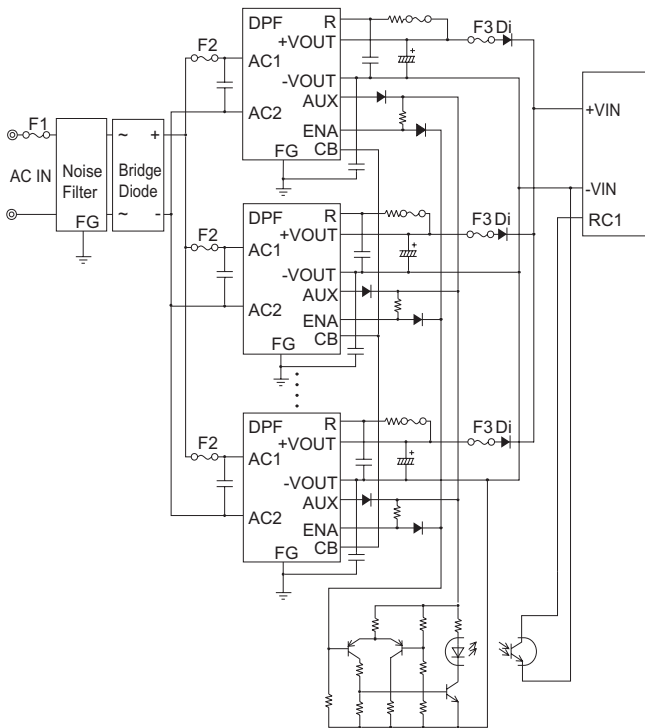


Fig.5.2 N+1 redundant operation

5.3 N+1 redundant operation

- It is possible to set N+1 redundant operation for improving reliability of power supply system. Connect as shown in Fig.5.2.
- Purpose of redundant operation is to ensure stable operation in the event of single power supply failure. Since extra power supply is reserved for the failure condition, so total power of redundant operation is equal to N.

6 Implementation - Mounting Method

6.1 Mounting method

- The unit can be mounted in any direction. When two or more power supplies are used side by side, position them with proper intervals to allow enough air ventilation. Aluminum base plate temperature around each power supply should not exceed the temperature range shown in derating curve.
- Avoid placing the AC input line pattern lay out underneath the unit, it will increase the line conducted noise. Make sure to leave an ample distance between the line pattern lay out and the unit. Also avoid placing the DC output line pattern of DC-DC converter underneath the unit because it may increase the output noise. Lay out the pattern away from the unit.

- High-frequency noise radiates directly from the unit to the atmosphere. Therefore, design the shield pattern on the printed circuit board and connect its one to FG. The shield pattern prevents noise radiation.

6.2 Stress onto the pins

- When too much stress is applied to the pins of the power supply, the internal connection may be weakened. As shown in Fig.6.1 avoid applying stress of more than 29.4N(3kgf) on the input pins/output pins(A part) and more than 9.8N(1kgf) to the signal pins(B part).
- The pins are soldered on PCB internally, therefore, do not pull or bend them with abnormal forces.
- Fix the unit on PCB(fixing fittings) to reduce the stress onto the pins.

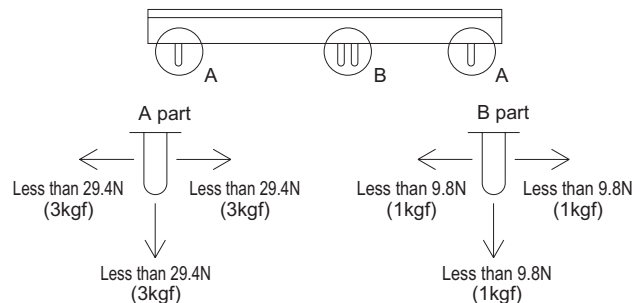


Fig.6.1 Stress onto the pins

6.3 Cleaning

- Clean the product with a blush. Prevent liquid from getting into the product. Do not soak the product into liquid.
- Do not stick solvent to a name plate or a resin case. (If solvent sticks to a name plate or a resin case, it will cause to change the color of the case or to fade letters on name plate away.)
- After cleaning, dry them enough.

6.4 Soldering

- Flow soldering : 260°C less than 15 seconds.
- Soldering iron :
 - AC IN/DC OUT/R pins : 450°C less than 5 seconds.
 - Signal pins : 350°C less than 3 seconds(less than 20W).

6.5 Derating

■ Use with the conduction cooling (e.g. heat radiation by conduction from the aluminum base plate to the attached heat sink).

Fig.6.2 shows the derating curve based on the aluminum base plate temperature. In the hatched area, the specification of Ripple and Ripple Noise is different from other areas.

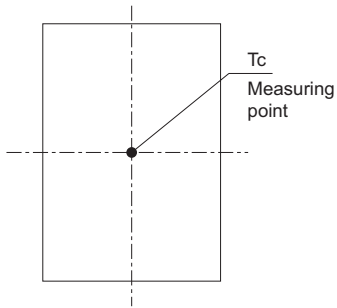
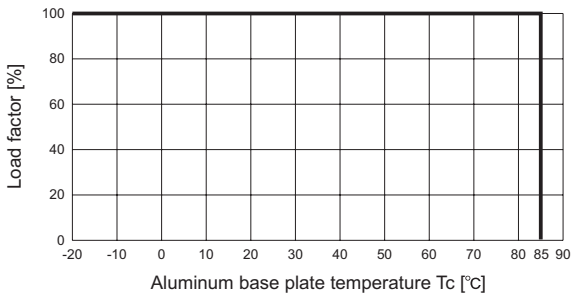


Fig.6.2 Derating curve